



**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

By  
ENTERED  
RCE FILED  
9/6/06  
C. Miller  
9-12

Application No.: 10/763,164

Filing Date: January 26, 2004

Applicant: Chan-Suk LEE

Group Art Unit: 2826

Examiner: Alexander O. Williams

Title: STACKED OFFSET SEMICONDUCTOR PACKAGE  
AND METHOD FOR FABRICATING (*As Amended*)

Attorney Docket: 2557-000200/US

Customer Service Window  
Randolph Building  
401 Dulany Street  
Alexandria, VA 22314  
Mail Stop **AF**

August 7, 2006

**AMENDMENT UNDER 37 C.F.R. § 1.116**

Sir:

In response to the Office Action (hereinafter "Action") mailed June 6, 2006, the following amendments and remarks are respectfully submitted in connection with the above-identified application:

	Claims remaining after Amendment		Highest number previously paid for		Present extra
Total	20	-	22/08/2006 JAD:01= 0000051 10763164		
Independent	7	-	01 FC:1201 5	=	400.00 OP 2